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74HC4016

Quad single-pole single-throw analog switch

Rev. 3 — 12 December 2016 Product data sheet

1. General description

The 74HC4016 is a quad single pole, single throw analog switch. Each switch features two input/output terminals (nY and nZ) and an active HIGH enable input (nE). When nE is LOW, the analog switch is turned off. Inputs include clamp diodes. This enables the use of current limiting resistors to interface inputs to voltages in excess of V_{CC}.

2. Features and benefits

- Input levels nE inputs:
  - For 74HC4016: CMOS level
- Typical ‘break before make’ built-in
- Low ON resistance:
  - 160 Ω (typical) at V_{CC} = 4.5 V
  - 120 Ω (typical) at V_{CC} = 6.0 V
  - 85 Ω (typical) at V_{CC} = 9.0 V
- Specified in compliance with JEDEC standard no. 7A
- ESD protection:
  - HBM JESD22-A114F exceeds 2000 V
  - MM JESD22-A115-A exceeds 200 V
- Specified from −40 °C to +85 °C and −40 °C to +125 °C

3. Ordering information

Table 1. Ordering information

Type number	Package			
	Temperature range	Name	Description	Version
74HC4016D	−40 °C to +125 °C	SO14	plastic small outline package; 14 leads; body width 3.9 mm	SOT108-1
74HC4016PW	−40 °C to +125 °C	TSSOP14	plastic thin shrink small outline package; 14 leads; body width 4.4 mm	SOT402-1

4. Functional diagram

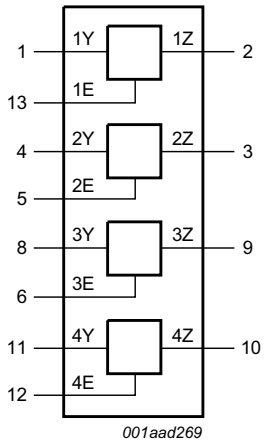


Fig 1. Logic symbol

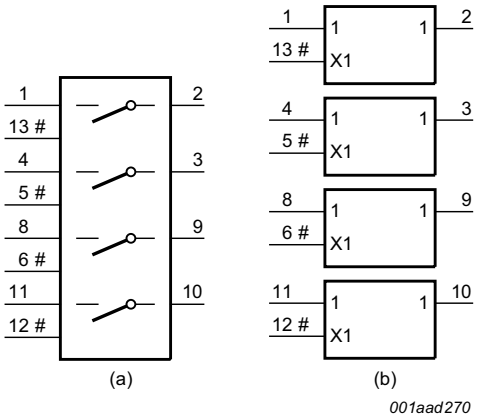


Fig 2. IEC logic symbol

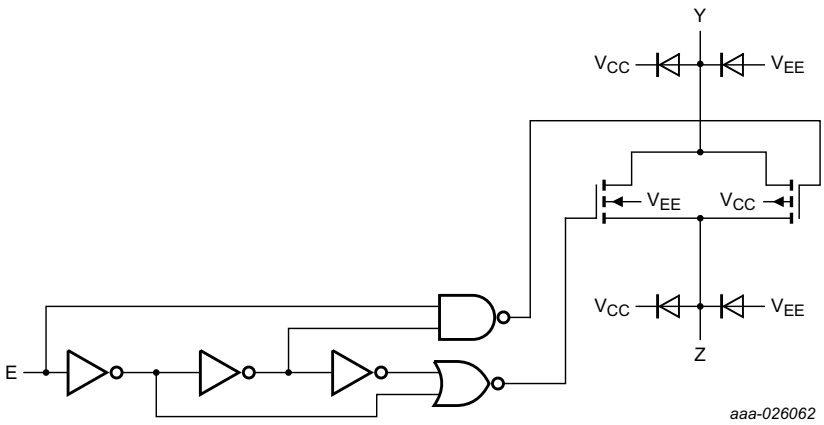


Fig 3. Schematic diagram (one switch)

5. Pinning information

5.1 Pinning

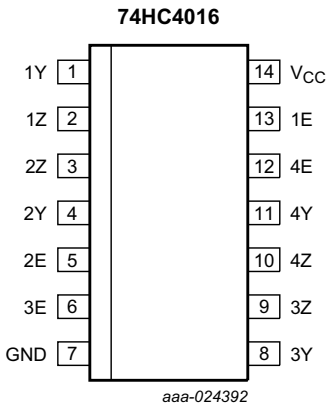


Fig 4. Pin configuration for SO14

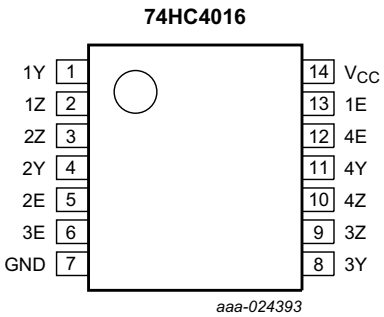


Fig 5. Pin configuration for TSSOP14

5.2 Pin description

Table 2. Pin description

Symbol	Pin	Description
1Z, 2Z, 3Z, 4Z	2, 3, 9, 10	independent input or output
1Y, 2Y, 3Y, 4Y	1, 4, 8, 11	independent input or output
GND	7	ground (0 V)
1E, 2E, 3E, 4E	13, 5, 6, 12	enable input (active HIGH)
V_{CC}	14	supply voltage

6. Functional description

Table 3. Function table[1]

Input nE	Switch
L	OFF
H	ON

[1] H = HIGH voltage level;
L = LOW voltage level.

7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
V_{CC}	supply voltage		−0.5	+11.0	V
I_{IK}	input clamping current	$V_I < -0.5$ V or $V_I > V_{CC} + 0.5$ V	-	±20	mA
I_{SK}	switch clamping current	$V_{SW} < -0.5$ V or $V_{SW} > V_{CC} + 0.5$ V	-	±20	mA
I_{SW}	switch current	$V_{SW} = -0.5$ V to $V_{CC} + 0.5$ V [1]	-	±25	mA
I_{CC}	supply current		-	+50	mA
I_{GND}	ground current		−50	-	mA
T_{stg}	storage temperature		−65	+150	°C
P_{tot}	total power dissipation	$T_{amb} = -40$ °C to +125 °C [2]			
		SO14 and TSSOP14 packages	-	500	mW
P	power dissipation	per switch	-	100	mW

[1] To avoid drawing V_{CC} current out of terminal nZ, when switch current flows in terminals nY, the voltage drop across the bidirectional switch must not exceed 0.4 V. If the switch current flows into terminal nZ, no V_{CC} current will flow out of terminals nY. In this case there is no limit for the voltage drop across the switch, but the voltages at nY and nZ may not exceed V_{CC} or GND.

[2] For SO14 package: P_{tot} derates linearly with 8 mW/K above 70 °C.
For TSSOP14 packages: P_{tot} derates linearly with 5.5 mW/K above 60 °C.

8. Recommended operating conditions

Table 5. Recommended operating conditions

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
V_{CC}	supply voltage		2.0	5.0	10.0	V
V_I	input voltage		GND	-	V_{CC}	V
V_{SW}	switch voltage		GND	-	V_{CC}	V
T_{amb}	ambient temperature		−40	+25	+125	°C
$\Delta t/\Delta V$	input transition rise and fall rate	V_{CC} = 2.0 V	-	-	625	ns/V
		V_{CC} = 4.5 V	-	1.67	139	ns/V
		V_{CC} = 6.0 V	-	-	83	ns/V
		V_{CC} = 10.0 V	-	-	35	ns/V

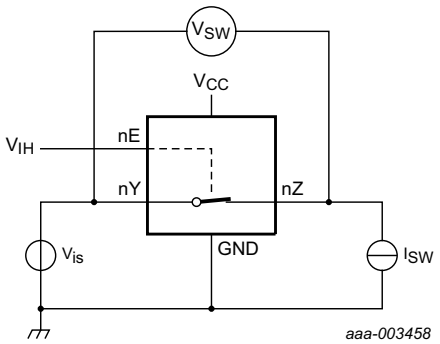
9. Static characteristics

Table 6. R_{ON} resistance per switch

$V_I = V_{IH}$ or V_{IL}; for test circuit see Figure 6.
V_{is} is the input voltage at a nY or nZ terminal, whichever is assigned as an input.
V_{os} is the output voltage at a nY or nZ terminal, whichever is assigned as an output.
For 74HC4016: V_{CC} − GND = 2.0 V, 4.5 V, 6.0 V and 9.0 V.

Symbol	Parameter	Conditions	+25 °C		–40 °C to +85 °C		–40 °C to +125 °C		Unit
			Typ	Max	Min	Max	Min	Max	
$R_{ON(peak)}$	ON resistance (peak)	V_{is} = V_{CC} to GND							
		V_{CC} = 2.0 V; I_{SW} = 0.1 mA [1]	-	-	-	-	-	-	Ω
		V_{CC} = 4.5 V; I_{SW} = 1 mA	160	320	-	400	-	480	Ω
		V_{CC} = 6.0 V; I_{SW} = 1 mA	120	240	-	300	-	360	Ω
		V_{CC} = 9.0 V; I_{SW} = 1 mA	85	170	-	213	-	255	Ω
$R_{ON(rail)}$	ON resistance (rail)	V_{is} = GND							
		V_{CC} = 2.0 V; I_{SW} = 0.1 mA [1]	160	-	-	-	-	-	Ω
		V_{CC} = 4.5 V; I_{SW} = 1 mA	80	160	-	200	-	240	Ω
		V_{CC} = 6.0 V; I_{SW} = 1 mA	70	140	-	175	-	210	Ω
		V_{CC} = 9.0 V; I_{SW} = 1 mA	60	120	-	150	-	180	Ω
		V_{is} = V_{CC}							
		V_{CC} = 2.0 V; I_{SW} = 0.1 mA [1]	170	-	-	-	-	-	Ω
		V_{CC} = 4.5 V; I_{SW} = 1 mA	90	180	-	225	-	270	Ω
		V_{CC} = 6.0 V; I_{SW} = 1 mA	80	160	-	200	-	240	Ω
		V_{CC} = 9.0 V; I_{SW} = 1 mA	65	135	-	170	-	205	Ω
ΔR_{ON}	ON resistance mismatch between channels	V_{is} = V_{CC} to GND							
		V_{CC} = 2.0 V [1]	-	-	-	-	-	-	Ω
		V_{CC} = 4.5 V	16	-	-	-	-	-	Ω
		V_{CC} = 6.0 V	12	-	-	-	-	-	Ω
		V_{CC} = 9.0 V	9	-	-	-	-	-	Ω

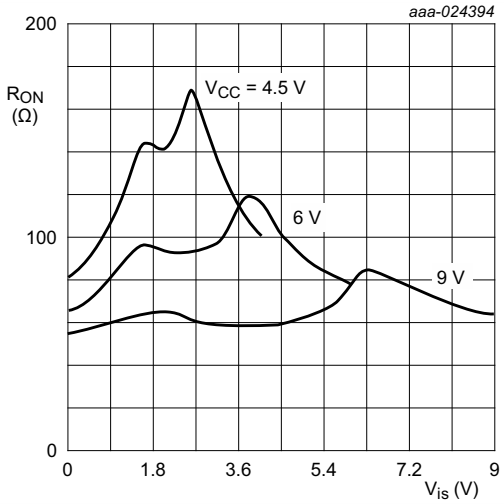
[1] At supply voltages (V_{CC} − GND) approaching 2 V, the analog switch ON resistance becomes extremely non-linear. Therefore it is recommended that these devices be used to transmit digital signals only, when using these supply voltages.



V_{is} = 0 V to V_{CC}

$$R_{ON} = \frac{V_{SW}}{I_{SW}}$$

Fig 6. Test circuit for measuring R_{ON}



V_{is} = 0 V to V_{CC}

Fig 7. Typical R_{ON} as a function of input voltage V_{is}

Table 7. Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).
V_{is} is the input voltage at a nY or terminal, whichever is assigned as an input.
V_{os} is the output voltage at a nY or nZ terminal, whichever is assigned as an output.

Symbol	Parameter	Conditions	Min	Typ[1]	Max	Unit
T_{amb} = +25 °C						
V_{IH}	HIGH-level input voltage	V_{CC} = 2.0 V	1.5	1.2	-	V
		V_{CC} = 4.5 V	3.15	2.4	-	V
		V_{CC} = 6.0 V	4.2	3.2	-	V
		V_{CC} = 9.0 V	6.3	4.3	-	V
V_{IL}	LOW-level input voltage	V_{CC} = 2.0 V	-	0.8	0.5	V
		V_{CC} = 4.5 V	-	2.1	1.35	V
		V_{CC} = 6.0 V	-	2.8	1.80	V
		V_{CC} = 9.0 V	-	4.3	2.70	V
I_I	input leakage current	V_I = V_{CC} or GND				
		V_{CC} = 6.0 V	-	-	±0.1	μA
		V_{CC} = 10.0 V	-	-	±0.2	μA
$I_{S(OFF)}$	OFF-state leakage current	V_{CC} = 10.0 V; V_I = V_{IH} or V_{IL}; $\|V_{SW}\|$ = V_{CC} − GND; see Figure 8				
		per channel	-	-	±0.1	μA
$I_{S(ON)}$	ON-state leakage current	V_{CC} = 10.0 V; V_I = V_{IH} or V_{IL}; $\|V_{SW}\|$ = V_{CC} − GND; see Figure 9	-	-	±0.1	μA

Table 7. Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).
V_{is} is the input voltage at a nY or terminal, whichever is assigned as an input.
V_{os} is the output voltage at a nY or nZ terminal, whichever is assigned as an output.

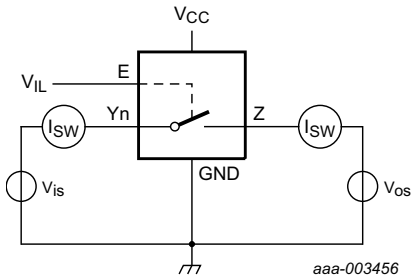
Symbol	Parameter	Conditions	Min	Typ[1]	Max	Unit
I_{CC}	supply current	$V_I = V_{CC}$ or GND; V_{is} = GND or V_{CC}; $V_{os} = V_{CC}$ or GND				
		V_{CC} = 6.0 V	-	-	2.0	μA
		V_{CC} = 10.0 V	-	-	4.0	μA
C_I	input capacitance		-	3.5	-	pF
C_{sw}	switch capacitance		-	5	-	pF
T_{amb} = –40 °C to +85 °C						
V_{IH}	HIGH-level input voltage	V_{CC} = 2.0 V	1.5	-	-	V
		V_{CC} = 4.5 V	3.15	-	-	V
		V_{CC} = 6.0 V	4.2	-	-	V
		V_{CC} = 9.0 V	6.3	-	-	V
V_{IL}	LOW-level input voltage	V_{CC} = 2.0 V	-	-	0.50	V
		V_{CC} = 4.5 V	-	-	1.35	V
		V_{CC} = 6.0 V	-	-	1.80	V
		V_{CC} = 9.0 V	-	-	2.70	V
I_I	input leakage current	$V_I = V_{CC}$ or GND				
		V_{CC} = 6.0 V	-	-	±1.0	μA
		V_{CC} = 10.0 V	-	-	±2.0	μA
$I_{S(OFF)}$	OFF-state leakage current	V_{CC} = 10.0 V; $V_I = V_{IH}$ or V_{IL}; $\|V_{SW}\| = V_{CC} - GND$; see Figure 8				
		per channel	-	-	±1.0	μA
$I_{S(ON)}$	ON-state leakage current	V_{CC} = 10.0 V; $V_I = V_{IH}$ or V_{IL}; $\|V_{SW}\| = V_{CC} - GND$; see Figure 9	-	-	±1.0	μA
I_{CC}	supply current	$V_I = V_{CC}$ or GND; V_{is} = GND or V_{CC}; $V_{os} = V_{CC}$ or GND				
		V_{CC} = 6.0 V	-	-	20.0	μA
		V_{CC} = 10.0 V	-	-	40.0	μA
T_{amb} = –40 °C to +125 °C						
V_{IH}	HIGH-level input voltage	V_{CC} = 2.0 V	1.5	-	-	V
		V_{CC} = 4.5 V	3.15	-	-	V
		V_{CC} = 6.0 V	4.2	-	-	V
		V_{CC} = 9.0 V	6.3	-	-	V
V_{IL}	LOW-level input voltage	V_{CC} = 2.0 V	-	-	0.50	V
		V_{CC} = 4.5 V	-	-	1.35	V
		V_{CC} = 6.0 V	-	-	1.80	V
		V_{CC} = 9.0 V	-	-	2.70	V
I_I	input leakage current	$V_I = V_{CC}$ or GND				
		V_{CC} = 6.0 V	-	-	±1.0	μA
		V_{CC} = 10.0 V	-	-	±2.0	μA

Table 7. Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).
V_{is} is the input voltage at a nY or terminal, whichever is assigned as an input.
V_{os} is the output voltage at a nY or nZ terminal, whichever is assigned as an output.

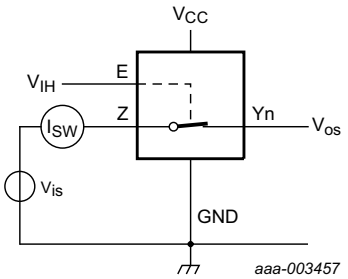
Symbol	Parameter	Conditions	Min	Typ[1]	Max	Unit
$I_{S(OFF)}$	OFF-state leakage current	V_{CC} = 10.0 V; V_I = V_{IH} or V_{IL}; $\|V_{SW}\|$ = V_{CC} − GND; see Figure 8				
		per channel	-	-	±1.0	μA
$I_{S(ON)}$	ON-state leakage current	V_{CC} = 10.0 V; V_I = V_{IH} or V_{IL}; $\|V_{SW}\|$ = V_{CC} − GND; see Figure 9	-	-	±1.0	μA
I_{CC}	supply current	V_I = V_{CC} or GND; V_{is} = GND or V_{CC}; V_{os} = V_{CC} or GND				
		V_{CC} = 6.0 V	-	-	40	μA
		V_{CC} = 10.0 V	-	-	80	μA

[1] Typical values are measured at T_{amb} = 25 °C.



V_{is} = V_{CC} and V_{os} = GND
V_{is} = GND and V_{os} = V_{CC}

Fig 8. Test circuit for measuring OFF-state leakage current



V_{is} = V_{CC} and V_{os} = open
V_{is} = GND and V_{os} = open

Fig 9. Test circuit for measuring ON-state leakage current

10. Dynamic characteristics

Table 8. Dynamic characteristics 74HC4066

GND = 0 V; $t_r = t_f$ = 6 ns; C_L = 50 pF unless specified otherwise; for test circuit see Figure 12.
V_{is} is the input voltage at a nY or nZ terminal, whichever is assigned as an input.
V_{os} is the output voltage at a nY or nZ terminal, whichever is assigned as an output.

Symbol	Parameter	Conditions	+25 °C		–40 °C to +85 °C		–40 °C to +125 °C		Unit
			Typ	Max	Min	Max	Min	Max	
t_{pd}	propagation delay	nY to nZ or nZ to nY; $R_L = \infty\ \Omega$; see Figure 10 [1]							
		V_{CC} = 2.0 V	17	60	-	75	-	90	ns
		V_{CC} = 4.5 V	6	12	-	15	-	18	ns
		V_{CC} = 6.0 V	5	10	-	13	-	15	ns
		V_{CC} = 9.0 V	4	8	-	10	-	12	ns
t_{on}	turn-on time	nE to nY or nZ; see Figure 11 [2]							
		V_{CC} = 2.0 V	52	190	-	240	-	235	ns
		V_{CC} = 4.5 V	19	38	-	48	-	57	ns
		V_{CC} = 5.0 V; C_L = 15 pF	16	-	-	-	-	-	ns
		V_{CC} = 6.0 V	15	32	-	41	-	48	ns
		V_{CC} = 9.0 V	11	28	-	35	-	42	ns
t_{off}	turn-off time	nE to nY or nZ; see Figure 11 [3]							
		V_{CC} = 2.0 V	47	145	-	180	-	220	ns
		V_{CC} = 4.5 V	17	29	-	36	-	44	ns
		V_{CC} = 5.0 V; C_L = 15 pF	14	-	-	-	-	-	ns
		V_{CC} = 6.0 V	14	25	-	31	-	38	ns
		V_{CC} = 9.0 V	13	22	-	28	-	33	ns
C_{PD}	power dissipation capacitance	per switch; V_I = GND to V_{CC} [4]	12	-	-	-	-	-	pF

[1] t_{pd} is the same as t_{PHL} and t_{PLH}.

[2] t_{on} is the same as t_{PHZ} and t_{PLZ}.

[3] t_{off} is the same as t_{PZH} and t_{PZL}.

[4] C_{PD} is used to determine the dynamic power dissipation (P_D in µW).
$P_D = C_{PD} \times V_{CC}^2 \times f_i + \Sigma\{(C_L + C_{sw}) \times V_{CC}^2 \times f_o\}$ where:
f_i = input frequency in MHz;
f_o = output frequency in MHz;
$\Sigma\{(C_L + C_{sw}) \times V_{CC}^2 \times f_o\}$ = sum of outputs;
C_L = output load capacitance in pF;
C_{sw} = switch capacitance in pF;
V_{CC} = supply voltage in V.

11. Waveforms

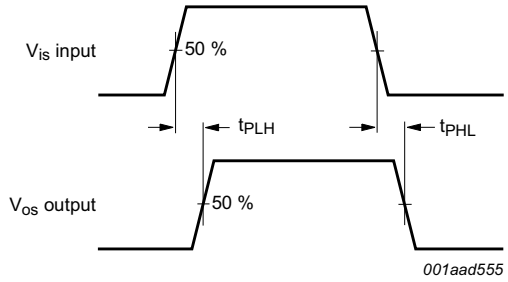
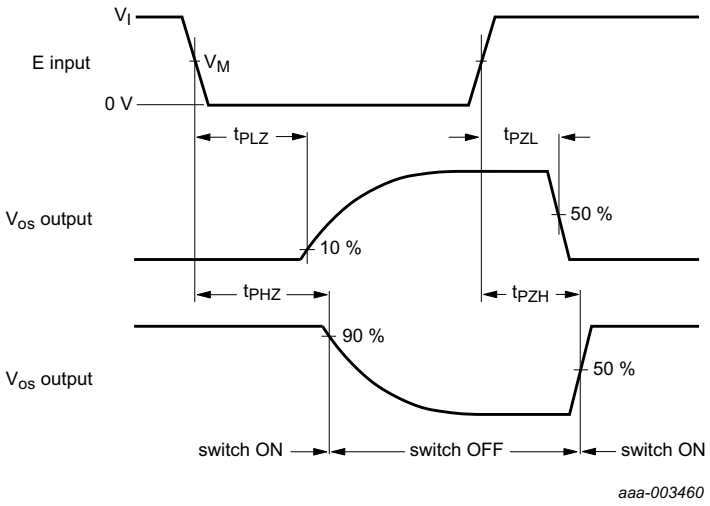


Fig 10. Input (V_{is}) to output (V_{os}) propagation delays

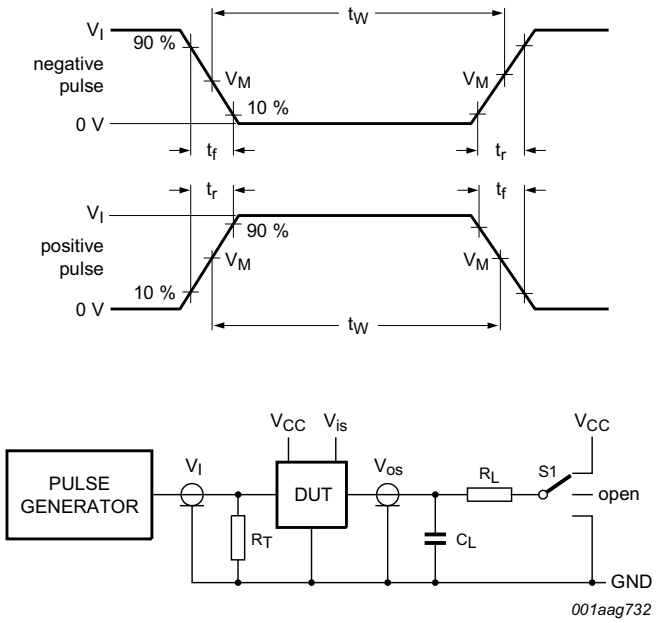


Measurement points are shown in Table 9.

Fig 11. Turn-on and turn-off times

Table 9. Measurement points

V_I	V_M
V_{CC}	$0.5V_{CC}$



Test data is given in Table 10.

Definitions test circuit:

R_T = Termination resistance should be equal to output impedance Z_o of the pulse generator.

C_L = Load capacitance including jig and probe capacitance.

R_L = Load resistance.

S1 = Test selection switch.

Fig 12. Test circuit for measuring switching times

Table 10. Test data

Test	Input			Output		S1 position
	Control nE	Switch nY (nZ)	t_r, t_f	Switch nZ (nY)		
	V_I	V_{is}		C_L	R_L	
t_{PHL}, t_{PLH}	GND	GND to V_{CC}	6 ns	50 pF	-	open
t_{PHZ}, t_{PZH}	GND to V_{CC}	V_{CC}	6 ns	50 pF, 15 pF	1 kΩ	GND
t_{PLZ}, t_{PZL}	GND to V_{CC}	GND	6 ns	50 pF, 15 pF	1 kΩ	V_{CC}

12. Additional dynamic characteristics

Table 11. Additional dynamic characteristics

Recommended conditions and typical values; GND = 0 V; T_{amb} = 25 °C.
V_{is} is the input voltage at a nY or nZ terminal, whichever is assigned as an input.
V_{os} is the output voltage at a nY or nZ terminal, whichever is assigned as an output.

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
THD	total harmonic distortion	f_i = 1 kHz; R_L = 10 kΩ; C_L = 50 pF; see Figure 13				%
		V_{CC} = 4.5 V; V_I = 4.0 V (p-p)	-	0.80	-	%
		V_{CC} = 9.0 V; V_I = 8.0 V (p-p)	-	0.40	-	%
		f_i = 10 kHz; R_L = 10 kΩ; C_L = 50 pF; see Figure 13				
		V_{CC} = 4.5 V; V_I = 4.0 V (p-p)	-	2.4	-	%
		V_{CC} = 9.0 V; V_I = 8.0 V (p-p)	-	1.2	-	%
$f_{(-3dB)}$	−3 dB frequency response	R_L = 50 Ω; C_L = 10 pF; see Figure 14 [2]				
		V_{CC} = 4.5 V	-	150	-	MHz
		V_{CC} = 9.0 V	-	160	-	MHz
α_{iso}	isolation (OFF-state)	R_L = 600 Ω; C_L = 50 pF; f_i = 1 MHz; see Figure 15 [1]				
		V_{CC} = 4.5 V	-	−50	-	dB
		V_{CC} = 9.0 V	-	−50	-	dB
V_{ct}	crosstalk voltage	between digital input and switch (peak to peak value); R_L = 600 Ω; C_L = 50 pF; f_i = 1 MHz; see Figure 16				
		V_{CC} = 4.5 V	-	110	-	mV
		V_{CC} = 9.0 V	-	220	-	mV
Xtalk	crosstalk	between switches; R_L = 600 Ω; C_L = 50 pF; f_i = 1 MHz; see Figure 17 [1]				
		V_{CC} = 4.5 V	-	−60	-	dB
		V_{CC} = 9.0 V	-	−60	-	dB

[1] Adjust input voltage V_{is} to 0 dBm level (0 dBm = 1 mW into 600 Ω).

[2] Adjust input voltage V_{is} to 0 dBm level at V_{os} for f_i = 1 MHz (0 dBm = 1 mW into 50 Ω). After set-up, f_i is increased to obtain a reading of −3 dB at V_{os}.

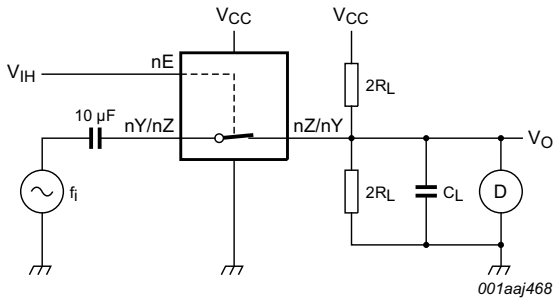
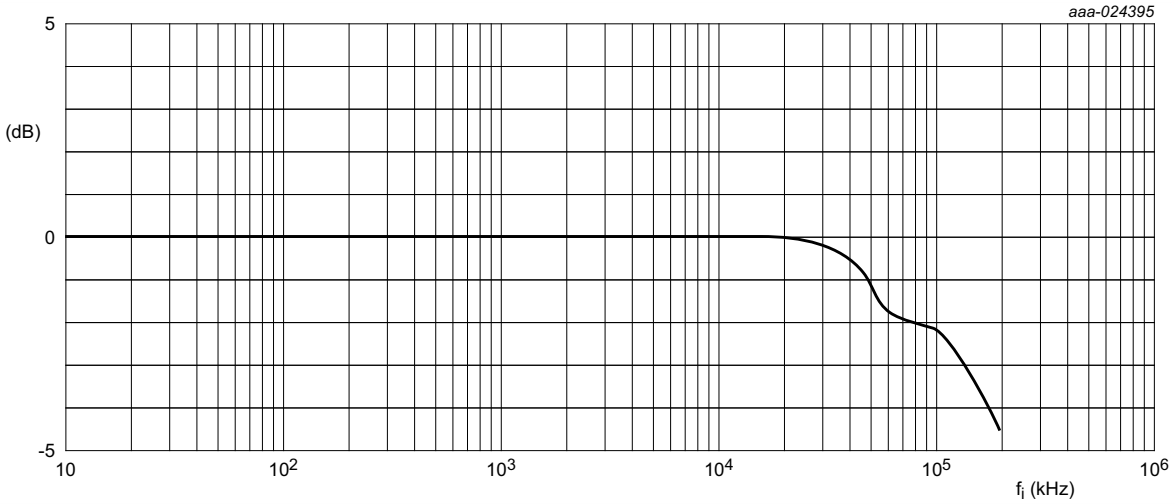
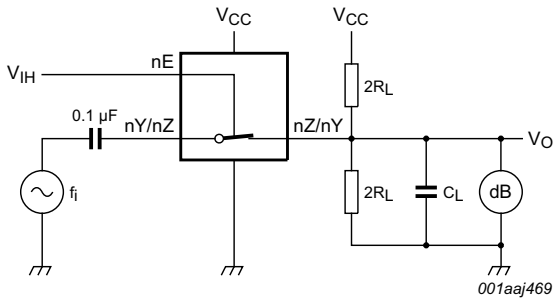


Fig 13. Test circuit for measuring total harmonic distortion



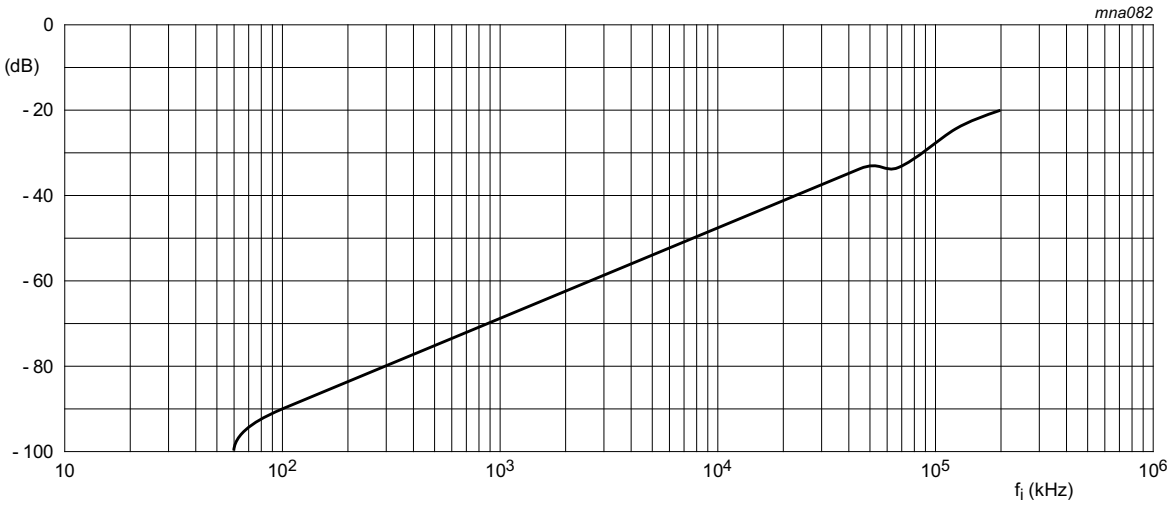
a. Typical −3 dB frequency response



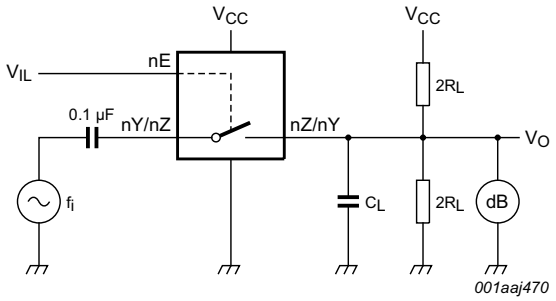
b. Test circuit

V_{CC} = 4.5 V; GND = 0 V; R_L = 50 Ω; R_{source} = 1 kΩ.

Fig 14. −3 dB frequency response



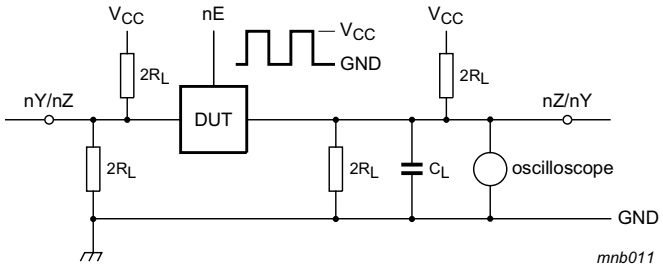
a. Isolation (OFF-state)



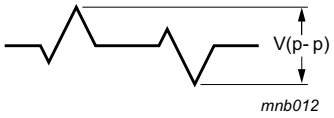
b. Test circuit

V_{CC} = 4.5 V; GND = 0 V; R_L = 600 Ω; R_{source} = 1 kΩ.

Fig 15. Isolation (OFF-state) as a function of frequency



a. Circuit



b. Crosstalk voltage

Fig 16. Test circuit for measuring crosstalk voltage (between the digital input and the switch)

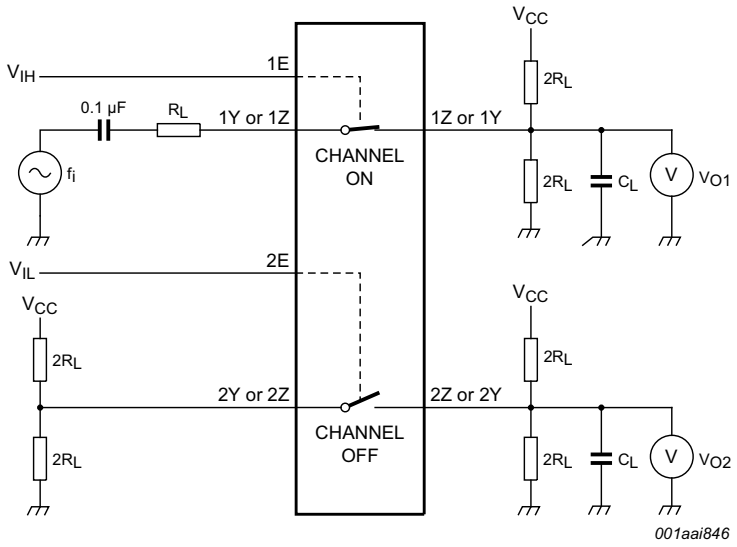
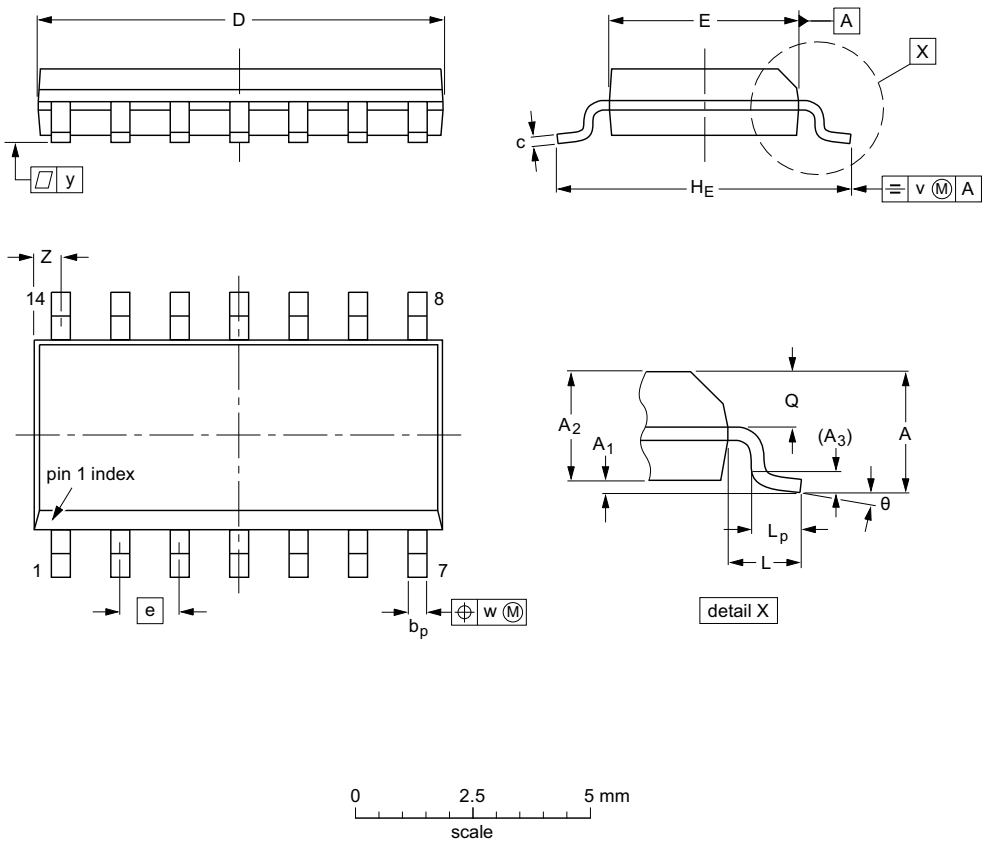


Fig 17. Test circuit for measuring crosstalk (between the switches)

13. Package outline

SO14: plastic small outline package; 14 leads; body width 3.9 mm **SOT108-1**



DIMENSIONS (inch dimensions are derived from the original mm dimensions)

UNIT	A max.	A_1	A_2	A_3	b_p	c	$D^{(1)}$	$E^{(1)}$	e	H_E	L	L_p	Q	v	w	y	$Z^{(1)}$	θ
mm	1.75	0.25 0.10	1.45 1.25	0.25	0.49 0.36	0.25 0.19	8.75 8.55	4.0 3.8	1.27	6.2 5.8	1.05	1.0 0.4	0.7 0.6	0.25	0.25	0.1	0.7 0.3	8^o 0^o
inches	0.069	0.010 0.004	0.057 0.049	0.01	0.019 0.014	0.0100 0.0075	0.35 0.34	0.16 0.15	0.05	0.244 0.228	0.041	0.039 0.016	0.028 0.024	0.01	0.01	0.004	0.028 0.012	

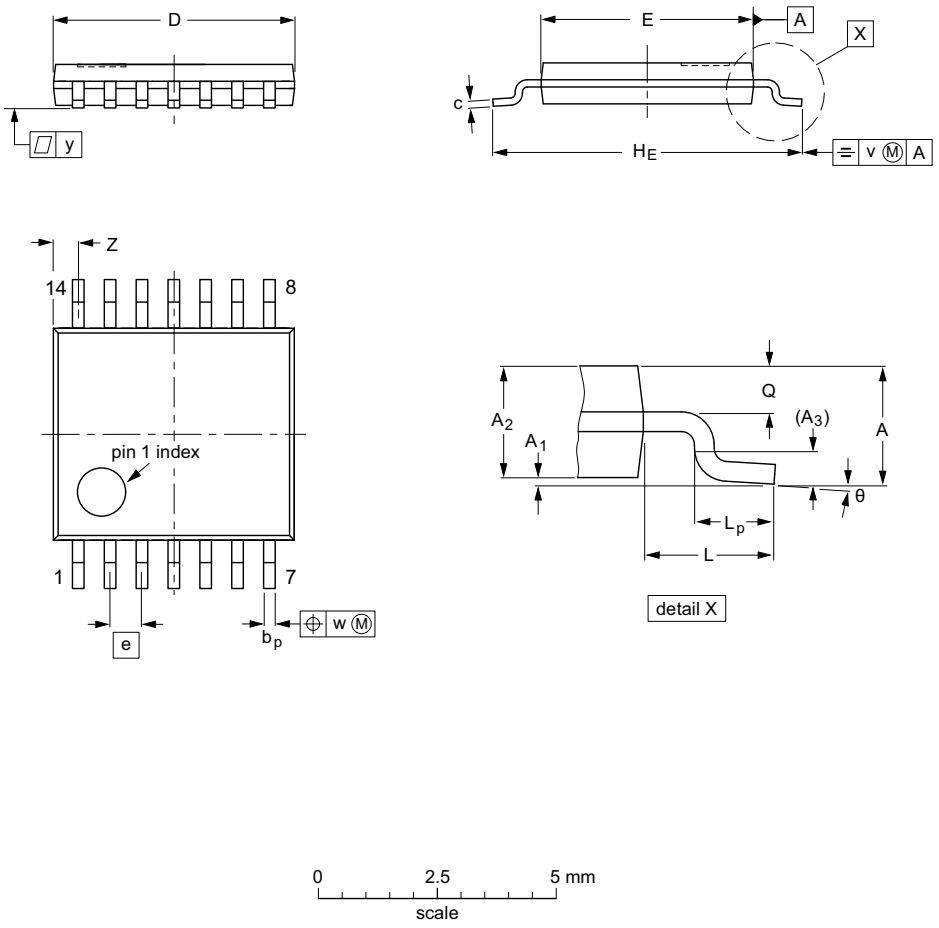
Note

1. Plastic or metal protrusions of 0.15 mm (0.006 inch) maximum per side are not included.

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	JEITA			
SOT108-1	076E06	MS-012				~~99-12-27~~ 03-02-19

Fig 18. Package outline SOT108-1 (SO14)

TSSOP14: plastic thin shrink small outline package; 14 leads; body width 4.4 mm **SOT402-1**



DIMENSIONS (mm are the original dimensions)

UNIT	A max.	A_1	A_2	A_3	b_p	c	D (1)	E (2)	e	H_E	L	L_p	Q	v	w	y	Z (1)	θ
mm	1.1	0.15 0.05	0.95 0.80	0.25	0.30 0.19	0.2 0.1	5.1 4.9	4.5 4.3	0.65	6.6 6.2	1	0.75 0.50	0.4 0.3	0.2	0.13	0.1	0.72 0.38	8° 0°

Notes

1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	JEITA			
SOT402-1		MO-153				~~99-12-27~~ 03-02-18

Fig 19. Package outline SOT402-1 (TSSOP14)

14. Abbreviations

Table 12. Abbreviations

Acronym	Description
CMOS	Complementary Metal-Oxide Semiconductor
DUT	Device Under Test
ESD	ElectroStatic Discharge
HBM	Human Body Model
MM	Machine Model

15. Revision history

Table 13. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
74HC4016 v.3	20161212	Product data sheet	-	74HC_HCT4016_CNV v.2
Modifications:	• Type numbers 74HC4016N, 74HCT4016N and 74HCT4016D removed.			
74HC_HCT4016_CNV v.2	19901201	Product specification	-	-

16. Legal information

16.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nexperia.com.

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18. Contents

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Date of release: 12 December 2016